Customer Care Solutions
NPM-6/6X Series Transceivers

System Module and User Interface

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Glossary of Terms

ACCIf	Accessory Interface block of MAD2WD1
ACI	Accessory Control Interface
ADC	Analog-Digital Converter
AEC	Acoustic Echo Canceller
AFC	Automatic Frequency Control
AEM	Auxiliary Energy Management ASIC
AGC	Automatic Gain Control
AIF	Application Interface
ALWE	Background noise suppressor
API	Application Programming Interface
ARM	Processor architecture
ASIC	Application Specific Integrated Circuit
BB	Baseband
BT	Bluetooth
CBus	Control Bus connecting UPP_WD2 with AEM and UEM
CCONT	Power management IC for digital phones
CCI	Camera Control Interface
CCP	Compact Camera Port
CIS	PCMCIA Card Information Structure
CMT	Cellular Mobile Telephone (MCU and DSP)
CPU	Central Processing Unit
CTSI	Clocking Timing Sleep Interrupt
COBBA_GJP	DCT3 RF-interface and audio codec ASIC with serial MAD interface
CSP	Chip Scale Package

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DAC	Digital-Analog Converter
DAI	Digital Audio Interface
DB	Dual band
DCT3	Digital Core Technology, 3rd generation
DCN	Offset Cancellation control signal
DLL	Dynamic Link Library
DRC	Dynamic Range Controller
DSP	Digital Signal Processor
EGSM	Extended – GSM
EFR	Enhanced Full Rate
EGPRS	Enhanced General Packet Radio Service
EMC	Electromagnetic compatibility
EMI	Electromagnetic Interference
EXT RF	External RF
FBUS	Asynchronous Full Duplex Serial Bus
GPRS	General Packet Radio Service
GSM	Global System for Mobile communications
HS	Half Rate Speech
HSCSD	High Speed Circuit Switched Data
IC	Integrated Circuit
I/O	Input/Output
IrDA	Infrared Association
LCD	Liquid Crystal Display
LNA	Low Noise Amplifier

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MBUS	1-wire half duplex serial bus
MCU	Micro Controller Unit
MDI	MCU-DSP Interface
MFI	Modulator and Filter Interface
PA	Transmit Power Amplifier
PC	Personal Computer
PCM	Pulse Code Modulation
PCM SIO	Synchronous serial bus for PCM audio transferring
PCMCIA	PC Memory Card International Association
PIFA	Planar Inverted F-antenna
PWB	Printed Wiring Board
RF	Radio Frequency
SIM	Subscriber Identity Module
SMART	PCMCIA interface ASIC
UEM	Universal Energy Management
UI	User Interface
UPP	Universal Phone Processor
VCXO	Voltage Controlled Crystal Oscillator
VCTCXO	Voltage Controlled Temperature Compensated Crystal Oscillator.

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Introduction

Electrical Modules

The system module AK4 consists of Radio Frequency (RF) and baseband (BB). User Interface (UI) contains display, keyboard, IR link, vibra, HF/HS connector and audio parts.

FM radio is located on the main PWB AK4.

The electrical part of the keyboard is located in separate UI PWB named KU4. KU4 is connected to radio PWB through spring connectors.

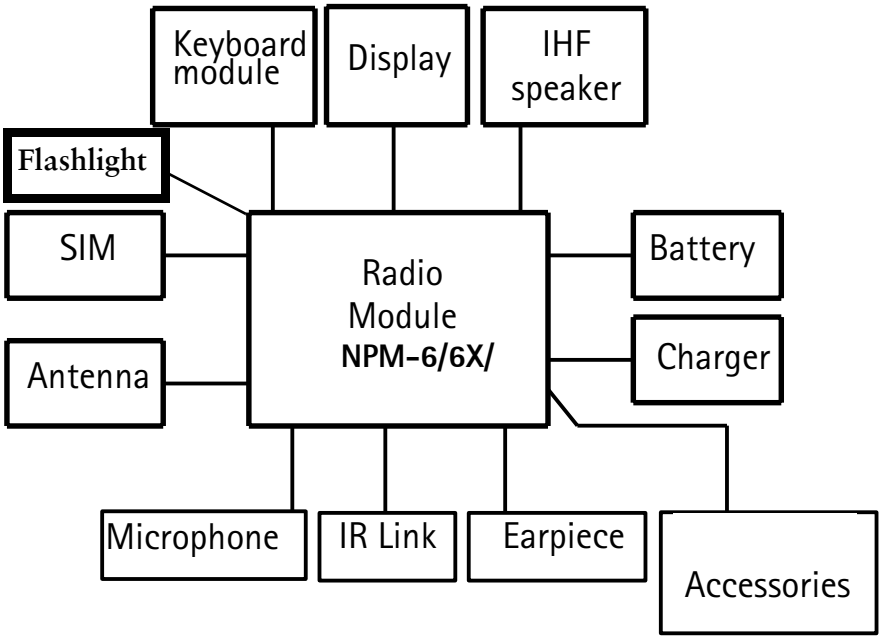
The Baseband blocks provide the MCU, DSP, external memory interface and digital control functions in the UPP ASIC. Power supply circuitry, charging, audio processing and RF control hard ware are in the UEM ASIC.

The purpose of the RF block is to receive and demodulate the radio frequency signal from the base station and to transmit a modulated RF signal to the base station.

The UI module is described in a dedicated section of the manual.

Interconnection Diagram

Figure 1: Interconnection diagram



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Temperature Conditions

Specifications are met within range of -10...+55 deg. C ambient temperature
Storage temperature range -40...+70 deg. C

Humidity

Relative humidity range is 5... 95%.
This module is not protected against water. Condensated or splashed water might cause malfunction momentary. Long term wetness will cause permanent damage.

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System Module

The System module (or Engine) consists of Baseband and RF sub-modules, each described below.

Baseband Module

Main functionality of the baseband is implemented into two ASICs: UPP (Universal Phone Processor) and UEM (Universal Energy Management).

UPP ASIC provides the MCU, DSP, external memory interface and digital control functions.

UEM ASIC contains power supply circuitry, charging, audio processing and RF control hardware.

The baseband architecture supports a power saving function called "sleep mode". This sleep mode shuts off the VCTCXO, which is used as system clock source for both RF and baseband. During the sleep mode the system runs from a 32 kHz crystal. The phone is waken up by a timer running from this 32 kHz clock supply. The sleep time is determined by net work parameters. Sleep mode is entered when both the MCU and the DSP are in standby mode and the normal VCTCXO clock is switched off.

NPM-6/6X supports both three and two wire type of Nokia chargers. Three wire chargers are treated like two wire ones. There is not separate PWM output for controlling charger but it is connected to GND inside the bottom connector. Charging is controlled by UEM ASIC (Universal Energy Management) and EM SW running in the UPP (Universal Phone Processor).

BL-4C Li-ion rechargeable battery is used as main power source for NPM-6/6X. BL-4C has a capacity of 720 mAh.

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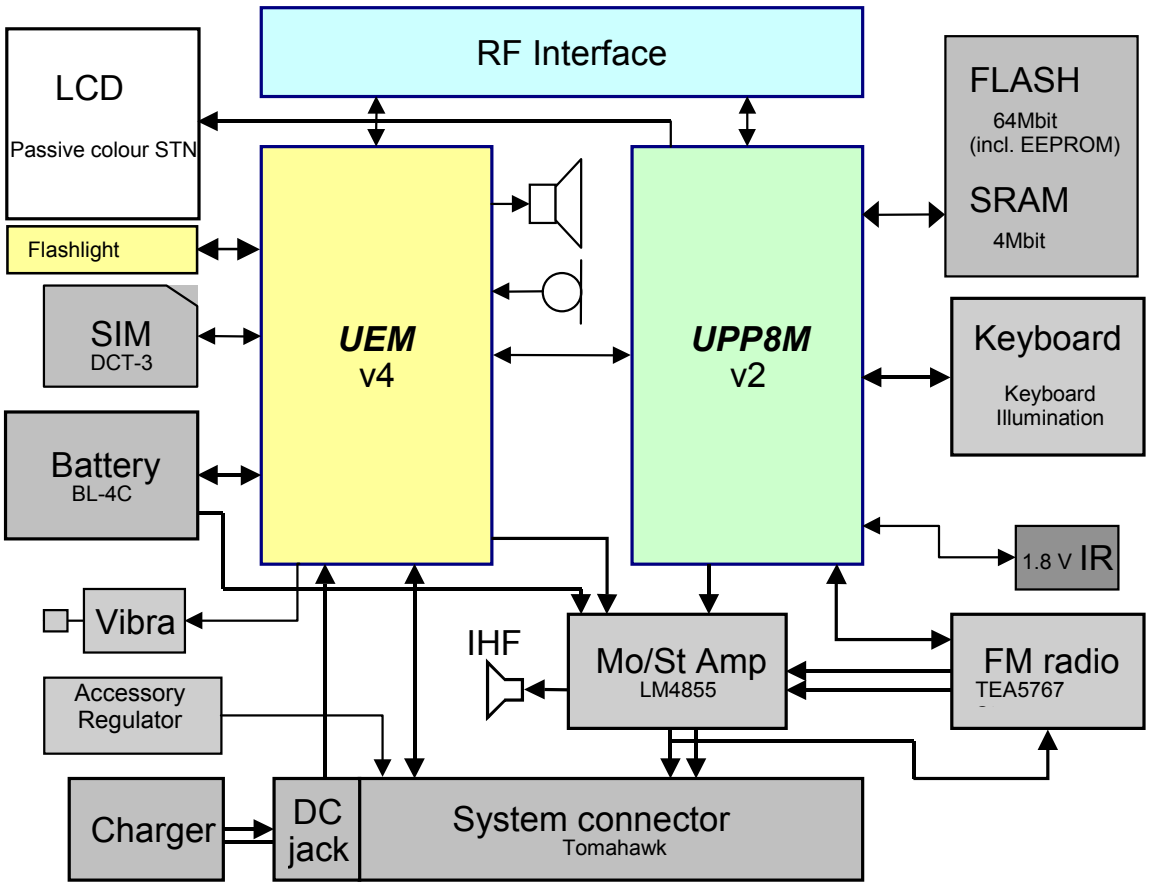
Block Diagram

Figure 2: Baseband block diagram



Technical Summary

Baseband of the NPM-6/6X is running from power rails 2.8V analog voltage and 1.8V I/O voltage. UPP core voltages can be lowered down to 1.0V, 1.3V and 1.5V. UEM includes 6 linear LDO (low drop-out) regulator for baseband and 7 regulator for RF. It also includes 4 current sources for biasing purposes and internal usage. UEM also includes SIM interface which has supports both 1.8V and 3V SIM cards.

A real time clock function is integrated into the UEM, which utilizes the same 32kHz clock supply as the sleep clock. A backup power supply is provided for the RTC-battery, which keeps the real time clock running when the main battery is removed. The backup power supply is a rechargeable surface mounted Li-Ion battery. The backup time with the battery is 30 minutes minimum.

The interface between the baseband and the RF section is mainly handled by the UEM ASIC**.** The UEM provides A/D and D/A conversion of the in-phase and quadrature receive and transmit signal paths and also A/D and D/A conversions of received and transmitted audio signals to and from the user interface. The UEM supplies the analog TXC and AFC signals to RF section according to the UPP DSP digital control.

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Data transmission between the UEM and the UPP is implemented using two serial busses, DBUS for DSP and CBUS for MCU. There are also separate signals for PDM coded audio. Digital speech processing is handled by the DSP inside UPP ASIC.

The UEM is a dual voltage circuit, the digital parts are running from the baseband supply 1.8V and the analog parts are running from the analog supply 2.78V also VBAT is directly used.

The baseband supports both internal and external microphone inputs and speaker outputs. Input and output signal source selection and gain control is performed by the UEM according to control messages from the UPP. Keypad tones, DTMF, and other audio tones are generated and encoded by the UPP and transmitted to the UEM for decoding. An external vibra alert control signals are generated by the UEM with separate PWM outputs.

NPM-6/6X has two serial control interfaces: FBUS and MBUS. FBUS can be accessed through a test pad and the System Connector as described later. The MBUS can be accessed through the production test pattern as described in section MBUS Interface.

Note! NPM-6 uses 64Mbit flash memory and external 4MBit SRAM memory. NPM-6X uses COMBO memory including 64MBit flash memory and 4Mbit SRAM.

EMC shielding is implemented using a metallized plastic frame. On the other side, the engine is shielded with PWB grounding.

DC Characteristics

Regulators and Supply Voltage Ranges

Absolute Maximum Ratings

Signal	Note
Battery Voltage (Idle)	-0.3V - 5.5V
Battery Voltage (Call)	Max 4.8V
Charger Input Voltage	-0.3V - 16V

Battery Voltage Range

Signal	Min.	Nom	Max	Note
VBAT	3.1V	3.7V	4.2V (charging high limit voltage)	3.1V SW cut off

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BB Regulators

Signal	Min.	Nom	Max	Note
VANA	2.70V	2.78V	2.86V	I_{max} = 80mA
VFLASH1	2.70V	2.78V	2.86V	I_{max} = 70mA I_{sleep} = 1.5mA
VFLASH2	2.70V	2.78V	2.86V	I_{max} = 40mA
VSIM	1.745V 2.91V	1.8V 3.0V	1.855V 3.09V	I_{max} = 25mA I_{sleep} = 0.5mA
VIO	1.72V	1.8V	1.88V	I_{max} = 150mA I_{sleep} = 0.5mA
VCORE	1.0V 1.235V 1.425V 1.710V	1.053V 1.3V 1.5V 1.8V	1.106V 1.365V 1.575V 1.890V	I_{max} = 200mA I_{sleep} = 0.2mA Default value 1.5V

Current Sources

Signal	Min.	Nom	Max	Note
IPA1 and IPA2		0mA - 5mA		Programmable, +/-6% V_{IPA1},V_{IPA1} = 0V - 2.7V
IPA3 and IPA4	0.5mA	1mA	1.5mA	V_{IPA1} = 0V - 2.7V

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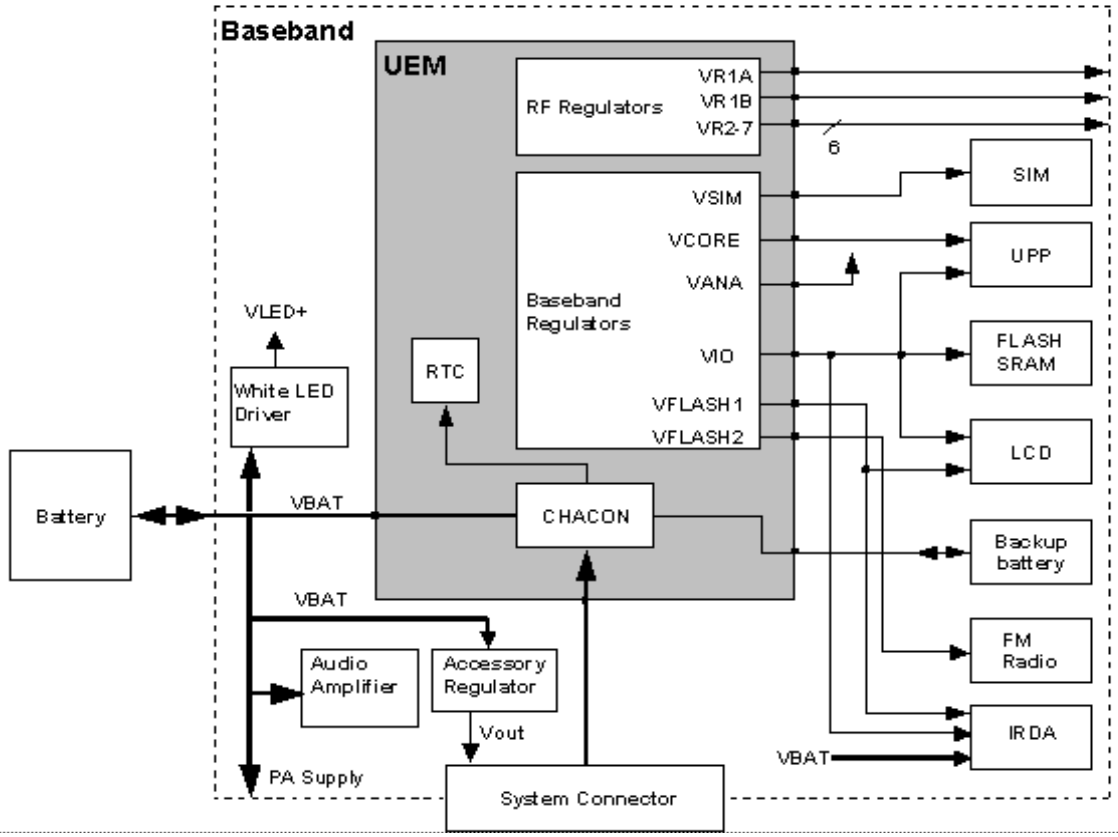
Power Distribution diagram



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External and Internal Signals and Connections

This section describes the external and internal electrical connection and interface levels on the baseband. The electrical interface specifications are collected into tables that covers a connector or a defined interface.

Digital Signals

AC and DC Characteristics of RF-BB digital signals

Signal name	From	To	Parameter	Input Characteristics				Function
				Min.	Typ	Max	Unit	
TXP	UPP GenIO 5	Helga	"1"	1.38		1.88	V	Power amplifier enable
			"0"	0		0.4	V	
			Load Resistance	10		220	kohm	
			Load Capacitance			20	pF	
			Timing Accuracy			1/4	symbol	
RFBusEna1X	UPP	Helga	"1"	1.38		1.88	V	RFbus enable
			"0"	0		0.4	V	
			Current			50	uA	
			Load resistance	10		220	kohm	
			Load capacitance			20	pF	
RFBusData	UPP	the Helga	"1"	1.38		1.88	V	RFbus data; read/write
			"0"	0		0.4	V	
			Load resistance	10		220	kohm	
			Load capacitance			20	pF	
			Data frequency			10	MHz	
RFBusClk	UPP	the Helga	"1"	1.38		1.88	V	RFbus clock
			"0"	0		0.4	V	
			Load resistance	10		220	kohm	
			Load capacitance			20	pF	
			Data frequency			10	MHz	

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RESET	UPP GenIO 6	the Helga	"1"	1.38		1.85	V	Reset to the Helga
			"0"	0		0.4	V	
			Load capacitance			20	pF	
			Load resistance	10		220	kohm	

Analogue Signals

Signal name	From	To	Parameter	Min	Typ	Max	Unit	Function
VCTCXO	VCTCXO	UPP	Frequency	13		26	MHz	High stability clock signal for the logic circuits, AC coupled. Distorted sinewave eg. sawtooth.
			Signal amplitude	0.2		1.32	Vpp	
			Input resistance	10			kohm	
			Input capacitance			10	pF	
			Harmonic content			-8	dBc	
			Clear signal window (no glitch)	200			mVpp	
			Duty cycle	40		60	%	
VCTCXOGnd	VCTCXO	UPP	DC level		0		V	Ground for reference clock
RXI/RXQ	Helga	UEM	Voltage swing (static)	1.35	1.4	1.45	Vpp	Received demodulated I- and Q-signals
			DC level	1.3	1.35	1.4	V	
			Input impedance	500			kohm	
TXIP / TXIN	UEM	the Helga	Differential voltage swing (static)	2.15	2.2	2.25	Vpp	Programmable voltage swing. Programmable common mode voltage. Between TXIP-TXIN
			DC level	1.17	1.20	1.23	V	
			Source impedance			200	ohm	

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TXQP / TXQN	UEM	Helga	Same as TXIP / TXIN					
AFC	UEM	VCTCXO	Voltage Min. Max	0.0 2.4		0.1 2.55	V	Automatic frequency control svoltage for the VCTCXO
			Source impedance			200	ohm	
			Load resistance capacitance	1		 100	kohm nF	
			Resolution		11		bits	
TXC	UEM	Helga	Voltage Min. Max	2.4		0.1	V	Transmitter power level and ramping control
			Source impedance			200	ohm	
			Load resistance capacitance	5		 15	kohm pF	
			Resolution		10		bits	
RFTemp	Helga	UEM	Voltage at -20 deg.C		1,57		V	Temperature sensor of the RF.
			Voltage at +25 deg.C		1,7			
			Voltage at +60 deg.C		1,79			

Keyboard (board-to-board) Connector

Pin	Signal	Min.	Nom	Max	Condition	Note
1	VLED+	7.2 V	0V 7.7 V	8.4 V	LED off LED on	Supply Voltage for Keyboard LEDs
2	VLED- (GND)	0.2 V	0V	0.35 V	LED off LED on	LED Katode Voltage
3	VLED+	7.2 V	0V 7.7 V	8.4V	LED off LED on	Supply Voltage for Keyboard LEDs
4	KEYB2	0.293V	0.309V	0.324V	25°C	Ambient temp. sensor on KU4
5	Not connected					
6	GND		0V			

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7	ROW (4)	0.7xVIO 0		1.8 V 0.3xVIO	High Low	Keyboard matrix row 4
8	ROW(3)	0.7xVIO 0		VIO 0.3xVIO	High Low	Keyboard matrix row 3
9	COL(2)	0.7xVIO 0		VIO 0.3xVIO	High Low	Keyboard matrix column 2
10	ROW(1)	0.7xVIO 0		VIO 0.3xVIO	High Low	Keyboard matrix row 1
11	COL(1)	0.7xVIO 0		VIO 0.3xVIO	High Low	Keyboard matrix column 1
12	ROW (0)	0.7xVIO 0		VIO 0.3xVIO	High Low	Keyboard matrix row 0
13	ROW (1)	0.7xVIO		VIO 0.3xVIO	High Low	Keyboard matrix row 1
14	COL (3)	0.7xVIO		VIO 0.3xVIO	High Low	Keyboard matrix column 3
15	COL(4)	0.7xVIO 0		VIO 0.3xVIO	High Low	Keyboard matrix column 4
16	GND		0V			
Note: VIO is specified in Table 3 'Baseband Regulators'						

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LCD Connector (Board to Board)

Pin	Signal	Min	Nom	Max	Condition	Note
1	VDDI	1.72V	1.8V	1.88V		Logic voltage supply Connected to VIO
2	RESX	0.7*VDDI 0		VDDI 0.3*VDDI	Logic '1' Logic '0'	Reset Active low
		1us			t_{rw}	Reset active
3	SDA	0.7*VDDI 0		VDDI 0.3*VDDI	Logic '1' Logic '0'	Serial data
		100ns			t_{sds}	Data setup time
		100ns			t_{sdh}	Data hold time
4	SCLK	0.7*VDDI 0		VDDI 0.3*VDDI 6.5MHz	Logic '1' Logic '0' Max fre-quency	Serial clock input
		250ns			t_{scyc}	Clock cycle
		100ns			t_{shw}	Clock high
		100ns			t_{slw}	Clock low
5	CSX	0.7*VDDI 0		VDDI 0.3*VDDI	Logic '1' Logic '0'	Chip select Active low
		60ns			t_{css}	CXS low before SCLK rising edge
		100ns			t_{csh}	CXS low after SCLK rising edge
6	VDD	2.70V	2.78V	2.86V		Supply Voltage. Connected to VFLASH1
7	NC					Not Connected
8	GND		0V			Ground
9	VLED- (GND)		0V			Return current
10	VLED Display	 7.2V	0V 7.7V	 8.4V	LED off LED on	Supply Voltage for LEDs

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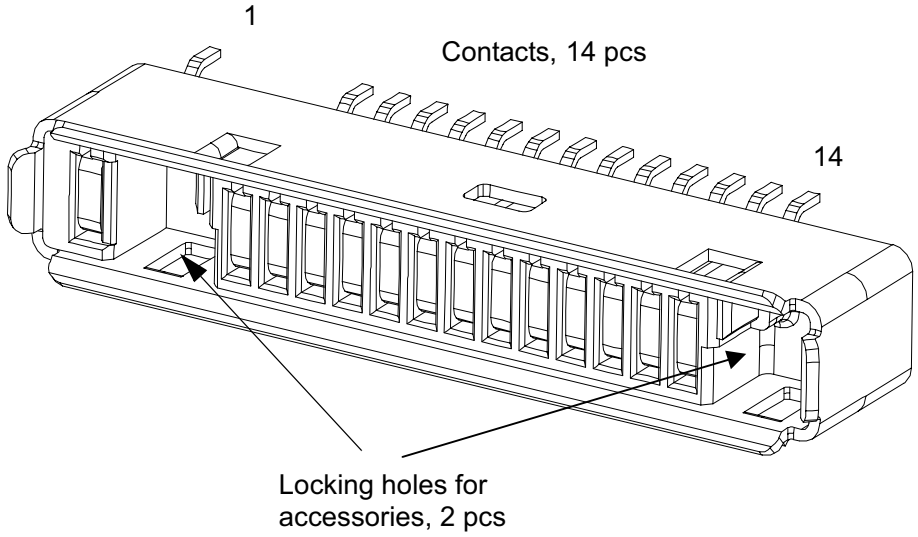
DC Connector

Pin	Signal	Min.	Nom	Max	Condition	Note
1	VCHAR		$11.1V_{peak}$	$16.9\ V_{peak}$ $7.9\ V_{RMS}$ $1.0\ A_{peak}$	Standard charger	Charger positive input
		$7.0\ V_{RMS}$	$8.4\ V_{RMS}$	$9.2\ V_{RMS}$ 850 mA	Fast charger	
2	CHGND		0			Charger ground

Bottom Connector

Bottom connector is of type Pop-Port (TM)

Figure 3: Bottom connector pinout



Bottom connector pins and signals:

Pin/Signal name	Signal description	Spectral range	Voltage / Current levels	Max or nominal serial impedance	Note
1 / Charge	V Charge	DC	0-9 V / 0.85 A		
2 / GND	Charge GND	- 0.85 A	100 mOhm (PWB + conn.)		
3 / ACI	ACI	1 kbit/s	Digital 0 / 2.5V-2.78V	47 Ohm (lowpass 50kHz)	Insertion & removal detection
4 / Vout	DC out	DC	2.78V 70mA 2.5V 90mA	500 mOhm (PWB + conn.)	200mW

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5 / USB Vbus	DC in	DC	4.375-5.25V		USB spec.
6 / USB D+ / FBUS RX		FBUS nominal 115k, fast FBUS 1.295M, USB 12M	USB 0-3.3V Fbus 0 / 2.5V-2.78V	33 Ohm	USB spec.
7 / USB D- / FBUS TX		FBUS nominal 115k, fast FBUS 1.295M, USB 12M	FBUS RX USB 0-3.3V Fbus 0 / 2.5V-2.78V	33 Ohm	USB spec.
8 / USB data GND	Data GND	-		ferrite	USB spec.
9 / XMIC N	Audio in	300 - 8kHz	1Vpp & 2.5V-2.78VDC		
10 / XMIC P	Audio in	300 - 8kHz	1Vpp & 2.5V-2.78VDC		
11 / HSEAR N	Audio out	20 - 20kHz	1Vpp	10 Ohm	
12 / HSEAR P	Audio out	20 - 20kHz	1Vpp	10 Ohm	
13 / HSEAR R N	Audio out	20 - 20kHz	1Vpp	10 Ohm	Not conn. In mono
14 / HSEAR R P	Audio out	20 - 20kHz	1Vpp	10 Ohm	Not conn. In mono

Table 1: Board to board connector pinlist (for PopPort Assembly)

Pin	Symbol	Pop-Port pin	Note	Max
1	Shield GND			
2	Charge	1	In current from charger	16V/2A
3	Charge GND	2	Return current	16V/2A
4	Shield GND			
5	ACI	3	Digital input	2.8V
6	Vout	4	Voltage output	2.8V/0.5A
7	USB Vbus	5	Voltage supply input	5V/1A
8	USB D+ /Fbus RX	6	Digital input	2.8V
9	USB D- /Fbus TX	7	Digital output	2.8V
10	Data GND	8	Return current	1.5A
11	XMIC N	9	Audio input	
12	XMIC P	10	Audio input	
13	XEAR N	11	Audio output	

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14	XEAR P	12	Audio output	
15	XEAR LN	13	Audio output	
16	XEAR LP	14	Audio output	
17	Shield GND			

SIM connector

Pin	Name	Parameter	Min.	Typ	Max	Unit	Notes
1	VSIM	1.8V SIM Card	1.6	1.8	1.9	V	Supply voltage
		3V SIM Card	2.8	3.0	3.2	V	
2	SIMRST	1.8V SIM Card	0.9xVSIM 0		VSIM 0.15xVSIM	V	SIM reset (output)
		3V SIM Card	0.9xVSIM 0		VSIM 0.15xVSIM	V	
3	SIMCLK	Frequency		3.25		MHz	SIM clock
		Trise/Tfall			50	ns	
		1.8V Voh 1.8V Vol	0.9xVSIM 0		VSIM	V	
		3V Voh 3V Vol	0.9xVSIM 0		VSIM	V	
4	DATA	1.8V Voh 1.8V Vol	0.9xVSIM 0		VSIM 0.15xVSIM	V	SIM data (output)
		3V Voh 3V Vol	0.9xVSIM 0		VSIM 0.15xVSIM		
		1.8V Vih 1.8V Vil	0.7xVSIM 0		VSIM 0.15xVSIM	V	SIM data (input) Trise/Tfall max 1us
		3V Vil 3V Vil	0.7xVSIM 0		VSIM 0.15xVSIM		
5	NC						Not connected
6	GND	GND	0		0	V	Ground

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Internal Signals and Connections

FM Radio Interface

BB Signal	FM Radio Signal	Min.	Nom	Max	Condition	Note
VFLASH2	Vcc1	2.7V	2.78V	2.86V		max. Icc1 19mA
	Vcc2	2.7V	2.78V	2.86V		max. Icc2 800uA
	VDD	2.7V	2.78V	2.86V		max. IDD 3mA
GenIO(3)	FMClk	1.4V 0	1.8V	1.88V 0.4V	High Low	Reference clock for FM radio module
			75581 kHz		Frequency	In GSM
		30ppm			Stability	
				2 µs	t_{rise}	rise / fall time
GenIO(8)	FMWrEn	1.4V 0V	1.8V	1.88V 0.4V	High Low	
		20µs			t_{wd}	*FMWrEn* high before rising edge of *FMCtrlClk* (write operation)
GenIO(11)	FMCtrlClk	1.4V 0	1.8V	1.88V 0.4V	High Low	max. 300kHz
				1 µs	t_r / t_f	rise / fall time
		50 ms			t_{start}	*FMCtrlClk* delay after switching on the VFLASH2 (oscillator running)
GenIO(12)	FMCtrlDa	1.4V 0	1.8V	1.88V 0.4V	High Low	Bidirectional
				14us	t_{da}	shift register available after "search ready"
		10 µs			t_{shift}	data available after *FMCtrlClk* rising edge (read operation)
		1.5 µs			t_{hold}	*FMCtrlDa* stable after *FMCtrlClk* rising edge (write operation)
GenIO(27)	FMTuneX	1.4V 0	1.8V	1.88V 0.4V	High Low	from FM module to UPP (FMCtrlClk = '1')

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MIC3P	FMAudio	228mV$_{pp}$	326mV$_{pp}$	460mV$_{pp}$		
		50dB			S/N	
				2%	Harmonic distortion	

Internal microphone

Signal	Min.	Nom	Max	Condition	Note
MICP			200mV$_{pp}$	AC	2.2kΩ to MIC1B
	2.0 V	2.1 V	2.25 V	DC	
MICN	2.0V	2.1V	2.25V	DC	

Internal speaker

Signal	Min.	Nom	Max	Condition	Note
EARP	0.75V	0.8V	2.0 V$_{pp}$ 0.85V	AC DC	Differential output (V$_{diff}$ = 4.0 V$_{pp}$)
EARN	0.75V	0.8V	2.0 V$_{pp}$ 0.85V	AC DC	

Headset connector

Pin	Signal	Min.	Nom	Max	Condition	Note
5	XMICP			1V$_{pp}$	G = 0dB	1kΩ to MIC2B
				100 mV$_{pp}$	G = 20dB	
		2.0 V	2.1 V	2.25 V	DC	
3	XMICN			1V$_{pp}$	G = 0 dB	1kΩ to GND
				100 mV$_{pp}$	G = 20dB	
4	XEARN	0.75V	0.8V	0.85V	DC	
				1V$_{pp}$	AC	
7	XEARP	0.75V	0.8V	0.85V	DC	
				1V$_{pp}$	AC	
5	HookInt	0V		2.86V (VFLASH1)		Connected to UEM AD-converter
6	HeadInt	0V		2.86V (VANA)		Accessory detection

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Functional Description

Modes of Operation

AK4 baseband has six different functional modes:

- No supply
- Back-up
- Acting Dead
- Active
- Sleep
- Charging

No Supply

In NO_SUPPLY mode, the phone has no supply voltage. This mode is due to disconnection of main battery and backup battery or low battery voltage level in both of the batteries.

Phone is exiting from *NO_SUPPLY* mode when sufficient battery voltage level is detected. Battery voltage can rise either by connecting a new battery with $VBAT > V_{MSTR+}$ or by connecting charger and charging the battery above V_{MSTR+}.

Back-up

In *BACK_UP* mode the backup battery has sufficient charge but the main battery can be disconnected or empty ($VBAT < V_{MSTR}$ *and* $VBACK > VBU_{COFF}$).

VRTC regulator is disabled in *BACK_UP* mode. VRTC output is supplied without regulation from backup battery (VBACK). All the other regulators are disabled in *BACK_UP* mode.

Acting Dead

If the phone is off when the charger is connected, the phone is powered on but enters a state called "*Acting Dead*". To the user, the phone acts as if it was switched off. A battery charging alert is given and/or a battery charging indication on the display is shown to acknowledge the user that the battery is being charged.

Active

In the *Active* mode the phone is in normal operation, scanning for channels, listening to a base station, transmitting and processing information. There are several sub-states in the active mode depending on if the phone is in burst reception, burst transmission, if DSP is working etc.

One of the sub-states of the active mode is FM radio on state. In that case, Audio Amplifier and FM radio are powered on. FM radio circuitry is controlled by the MCU and

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13MHz-reference clock is generated in the UPP. VFLASH2 regulator is operating.

In *Active* mode the RF regulators are controlled by SW writing into EM's registers wanted settings: VR1A can be enabled or disabled. VR2 can be enabled or disabled and its output voltage can be programmed to be 2.78V or 3.3V. VR4 -VR7 can be enabled, disabled, or forced into low quiescent current mode. VR3 is always enabled in Active mode.

Sleep Mode

Sleep mode is entered when both MCU and DSP are in stand–by mode. Sleep is controlled by both processors. When SLEEPX low signal is detected UEM enters SLEEP mode. VCORE, VIO and VFLASH1 regulators are put into low quiescent current mode. All the RF regulators are disabled in SLEEP. When SLEEPX=1 detected UEM enters ACTIVE mode and all functions are activated.

The sleep mode is exited either by the expiration of a sleep clock counter in the UEM or by some external interrupt, generated by a charger connection, key press, headset connection etc.

In sleep mode VCTCXOr is shut down and 32 kHz sleep clock oscillator is used as reference clock for the baseband.

Charging

Charging can be performed in any operating mode.

NPM-6/6X supports the standard NMP charger interface.

Supported chargers are ACP-7, ACP-8, ACP-9, ACP-12, LCH-8 and LCH-9.

Charging is controlled by the UEM ASIC and external components are needed for EMC, reverse polarity and transient protection of the input to the baseband module. The charger connection is through the system connector interface. The NPM-6/6X baseband is designed to support DCT3 chargers from an electrical point of view. Both 2- and 3-wire type chargers are supported.

The operation of the charging circuit has been specified in such a way as to limit the power dissipation across the charge switch and to ensure safe operation in all modes.

Battery

720 mAh Li-ion battery pack BL-4C is used in NPM-6/6X.

Nominal discharge cut-off voltage	3.1V
Nominal battery voltage	3.7V
Nominal charging voltage	4.2V
Maximum charger output current	850 mA
Minimum charger output current	200 mA

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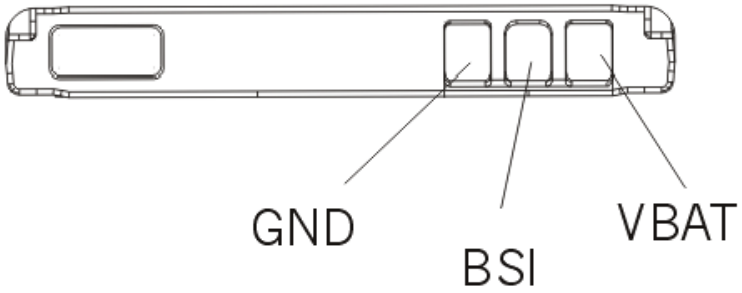
Pin numbering of battery pack

Signal name	Pin number	Function
VBAT	1	Positive battery terminal
BSI	2	Battery capacity measurement (fixed resistor inside the battery pack)
GND	3	Ground/negative/common battery terminal

BL-4C battery pack pin order

Figure 4: Battery Pack Contents



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Power Up and Reset

Power up and reset is controlled by the UEM ASIC. NPM-6/6X baseband can be powered up in following ways:

Press power button which means grounding the PWRONX pin on UEM

Connect the charger to the charger input

Supply battery voltage to the battery pin.

RTC Alarm, the RTC has been programmed to give an alarm

After receiving one of the above signals, the UEM counts a 20ms delay and then enters its reset mode. The watchdog starts up, and if the battery voltage is greater than Vcoff+ a 200ms delay is started to allow references etc. to settle. After this delay elapses the VFLASH1 regulator is enabled.

500us later VR3, VANA, VIO and VCORE are enabled. Finally the PURX line is held low for 20 ms. This reset, PURX, is fed to the baseband ASIC UPP, resets are generated for the DSP and the MCU. During this reset phase the UEM forces the VCXO regulator on regardless of the status of the sleep control input signal to the UEM. The sleep signal from the ASIC is used to reset the flash during power up and to put the flash in power down during sleep. All baseband regulators are switched on at the UEM power on except for the SIM regulator that is controlled by the MCU. The UEM internal watchdog is running during the UEM reset state, with the longest watchdog time selected. If the watchdog expires, the UEM returns to power off state. The UEM watchdog is internally acknowledged at the rising edge of the PURX signal in order to always give the same watchdog response time to the MCU.

A/D Channels

The UEM contains the following A/D converter channels that are used for several measurement purpose. The general slow A/D converter is a 10 bit converter using the UEM interface clock for the conversion. An interrupt will be given at the end of the measurement.

The UEM's 11-channel analog to digital converter is used to monitor charging functions, battery functions, user interface and RF functions.

When the conversion is started the converter input is selected. Then the signal processing block creates a data with MSB set to'1' and others to'0'. In the D/A converter this data controls the switches which connect the input reference voltage (VrefADC) to the resistor network. The generated output voltage is compared with the input voltage under measurement and if the latter is greater, MSB remains'1' else it is set'0'. The following step is to test the next bit and the next...until LSB is reached. The result is then stored to ADCR register for UPP to read.

The monitored battery functions are battery voltage (VBATADC), battery type (BSI) and

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battery temperature (BTEMP) indication.

The battery type is recognized through a resistive voltage divider. In phone there is a 100kΩ pull up resistor in the BSI line and the battery has a pull down resistor in the same line. Depending on the battery type the pull down resistor value is changed. The battery temperature is measured equivalently except that the systemboard has an NTC pull down resistor in the BTEMP line.

KEYB1&2 inputs are used for ambient temperature sensor. These inputs are also routed internally to the miscellaneous block.

The monitored RF function is PATEMP detection. PATEMP input is used to measure temperature of the RFIC, the Helga.

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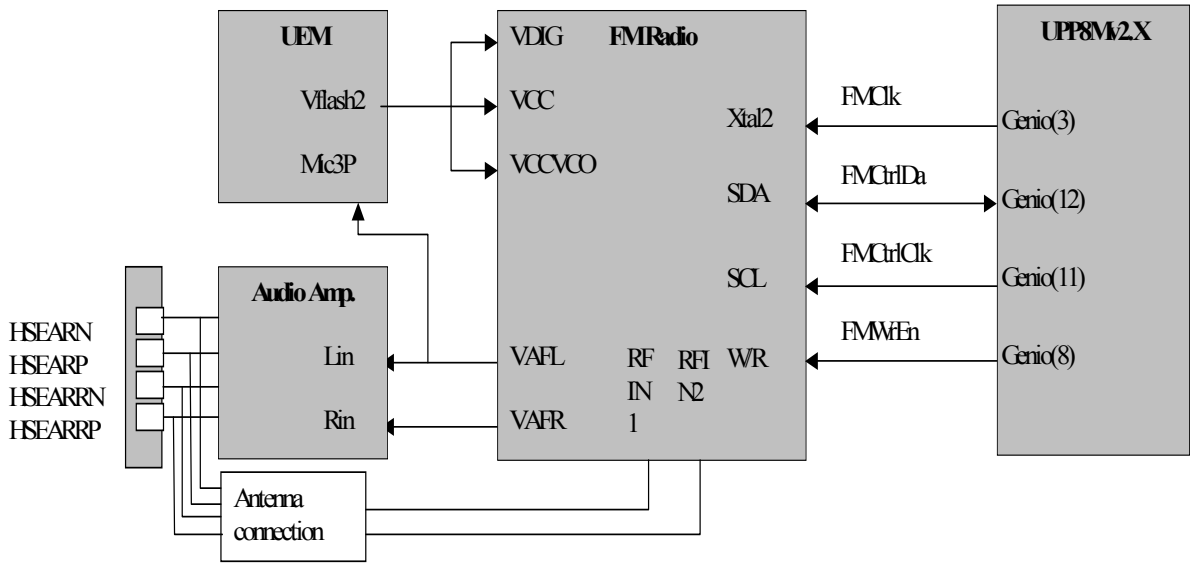
FM Radio

FM radio circuitry is implemented using the integrated radio IC, TEA5767. Only a few external components like filters, discriminator and capacitors are needed.

TEA5767 is an integrated AM/FM stereo radio circuit including digital tuning and control functions. NPM-6/6X radio is implemented as FM stereo receiver.

Figure 5: FM radio



IR Module

The IR interface when using transceiver with 1.8V I/O is designed into the UPP. The IR link supports speeds from 9600 bit/s to 1.152 MBit/s up to distance of 80 cm. Transmission over the IR if half-duplex.

Backup Battery

Backup battery is used in case when main battery is either removed or discharged. Backup battery is used for keeping real-time clock running for minimum of 30 minutes.

Rechargeable backup battery is connected between UEM VBACK and GND. In UEM backup battery charging high limit is set to 3.2V. The cut–off limit voltage (V BUCoff–) for backup battery is 2.0V. Backup battery charging is controlled by MCU by writing into UEM register.

Li-Ion SMD battery type is used. The nominal capacity of the battery is 0.01 mAh.

SIM Interface

UEM contains the SIM interface logic level shifting. SIM interface can be programmed to support 3V and 1.8V SIMs. SIM supply voltage is selected by a register in the UEM. It is only allowed to change the SIM supply voltage when the SIM IF is powered down.

The SIM power up/down sequence is generated in the UEM. This means that the UEM

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generates the RST signal to the SIM. Also the SIMCardDet signal is connected to UEM. The card detection is taken from the BSI signal, which detects the removal of the battery.

The SIM interface is powered up when the SIMCardDet signal indicates "card in". This signal is derived from the BSI signal.

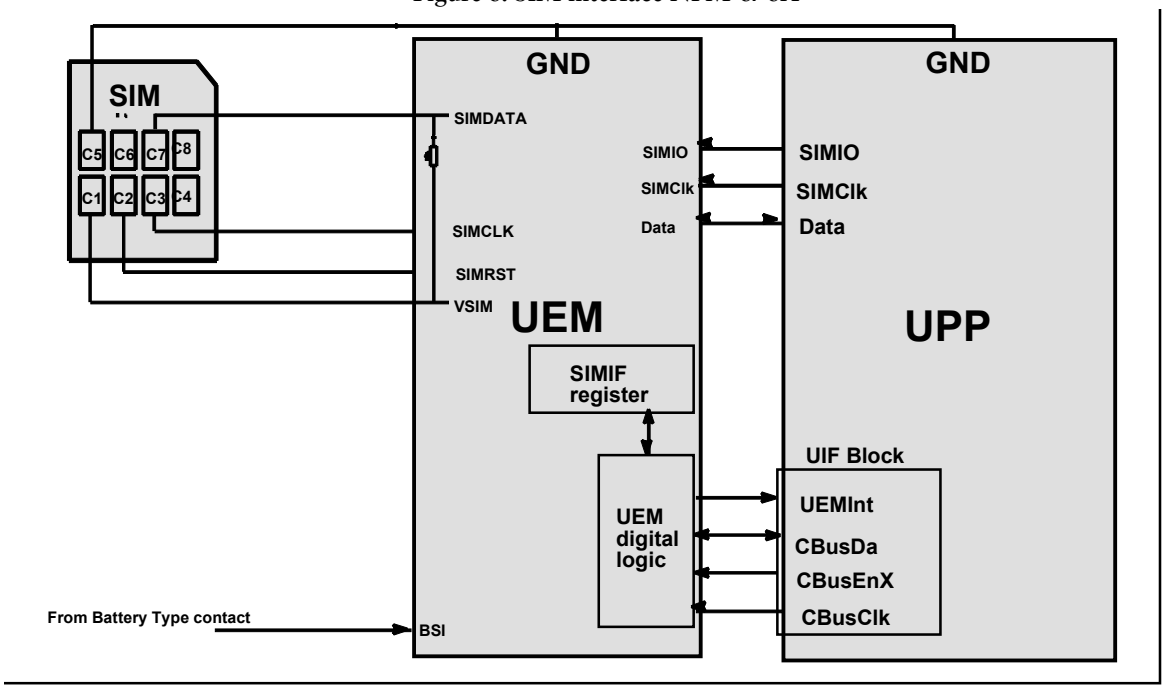
Parameter	Variable	Min.	Typ	Max	Unit
SIMCARDet, BSI comparator Threshold	Vkey	1.94	2.1	2.26	V
SIMCARDet, BSI comparator Hysteresis (1)	Vsimhyst	50	75	100	mV

The entire SIM interface locates in two chips: UPP and UEM.

The SIM interface in the UEM contains power up/down, port gating, card detect, data receiving, ATR-counter, registers and level shifting buffers logic. The SIM interface is the electrical interface between the Subscriber Identity Module Card (SIM Card) and mobile phone (via UEM device).

The data communication between the card and the phone is asynchronous half duplex. The clock supplied to the card is in GSM system 1.083 MHz or 3.25 MHz.

Figure 6: SIM interface NPM-6/6X



ACI

ACI is a point-to-point, bi-directional serial bus. ACI has two main features: **1**)The insertion and removal detection of an accessory device **2**) acting as a data bus, intended mainly for control purposes. A third function provided by ACI is to identify and authenticate the specific accessory which is connected to the System interface.

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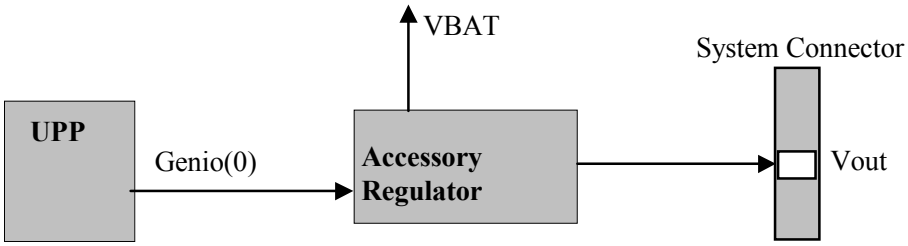
External Accessory Regulator

An external LDO Regulator exists for accessory power supply purposes. All ACI-accessories require this power supply. Regulator input is connected to battery voltage VBAT and output is connected to Vout pin in the system connector. Regulator is controlled via UPP (On/Off-function).

Accessory Regulator Signals

Signal	Min.	Nom	Max	Note
Vout	2.70V	2.78	2.86V	I_{max} = 150mA
GenIO(0)	1.4	1.8	1.88 0.6	High (ON) Low (OFF)

Figure 7: External Accessory regulation



External Audio

NPM-6/6X is designed to support fully differential external audio accessory connection. A headset can be directly connected to the system connector. With NPM-6/6X, two different kinds of headsets can be used; Stereo and Mono headset. Headset is also used as antenna input for the FM radio.

Headset implementation uses separate microphone and earpiece signals. The accessory is detected by the HeadInt signal when the plug is inserted. Normally when no plug is present the internal pull-down on the HF pin pulls down the HeadInt signal.

Due to the that the comparator level is 1.9V the HeadInt signal will not change state even if the HF output is biased to 0.8V. When the plug is inserted the switch is opened and the HeadInt signal is pulled up by the internal pull-up. The 1.9V threshold level is reached and the comparator output changes to low state causing an interrupt.

The hook signal is generated by creating a short circuit between the headset microphone signals. When no accessory is present, the HookInt signal is pulled up by the UEM resistor.

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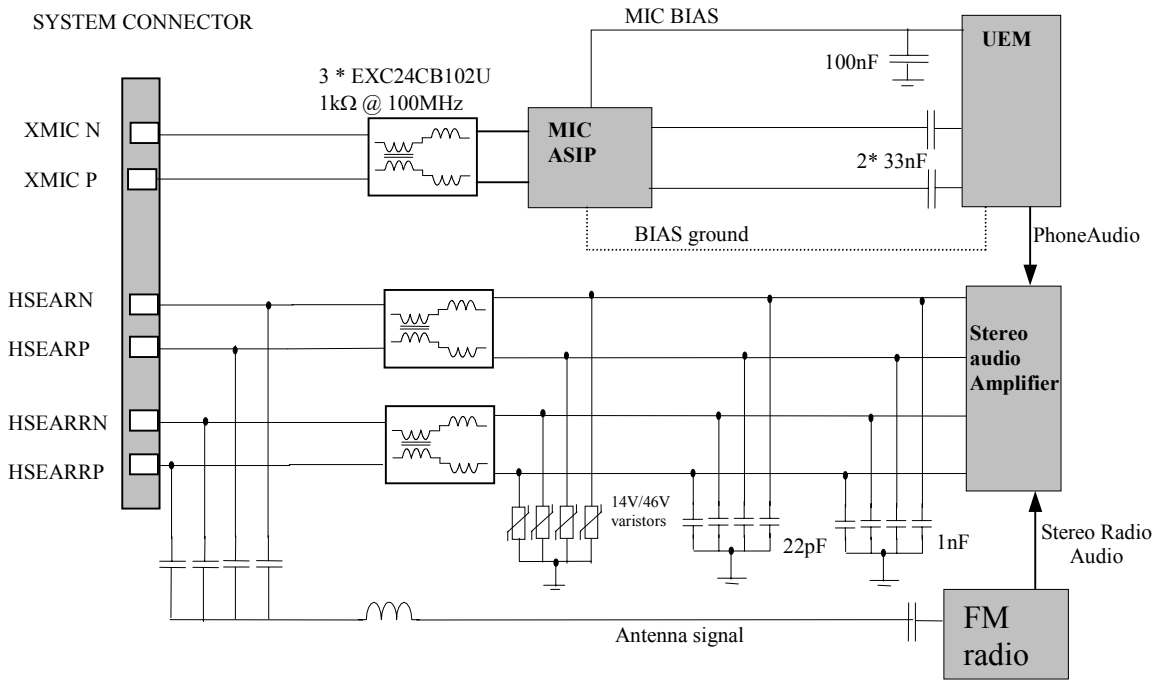
Figure 8: External audio connection



When the accessory is inserted and the microphone path is biased the HookInt signal decreases to 1.8V due to the microphone bias current flowing through the resistor. When the button is pressed the microphone signals are connected together, and the HookInt input will get half of micbias dc value 1.1 V. This change in DC level will cause the Hook-Int comparator output to change state, in this case from 0 to 1. The button can be used for answering incoming calls but not to initiate outgoing calls.

internal Audio

IHF Speaker & Stereo Audio Amplifier

Integrated HandsFree Speaker is used to generate alerting and warning tones in NPM-6/6X. IHF Speaker is controlled by an Audio amplifier . Speaker capsule is mounted in the C-cover. Spring contacts are used to connect the IHF Speaker contacts to the main PWB.

Figure 9: IHF speaker and amplifier

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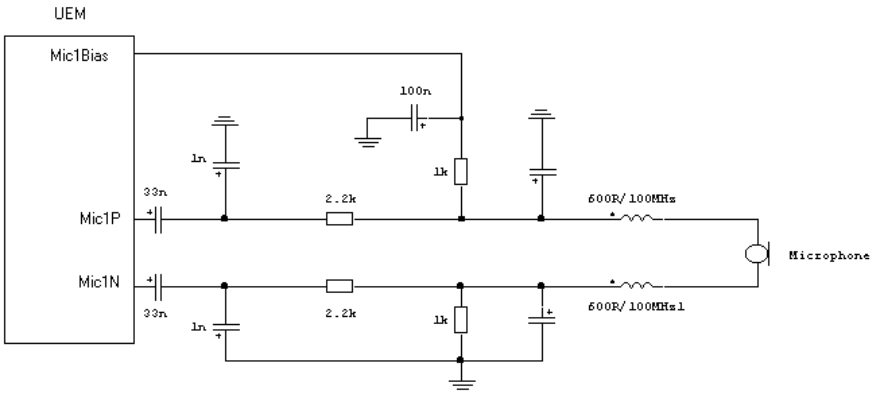
Internal Microphone

The internal microphone is connected to the UEM microphone input. The microphone input is symmetric and microphone bias is provided by the UEM. The microphone input on the UEM is ESD protected. Microphone capsule is mounted in the System Connector Assembly. Spring contacts are used to connect the microphone contacts to the main PWB.

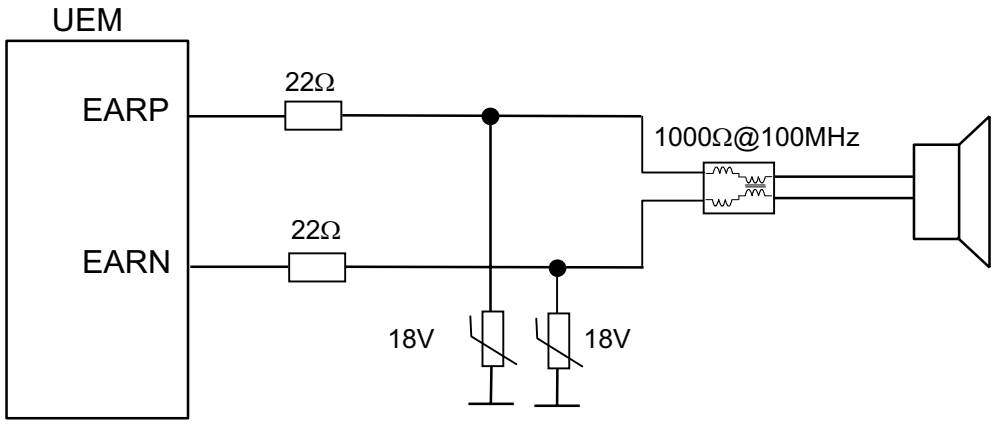
Figure 10: Internal microphone



Internal Speaker

The internal earpiece is a dynamic earpiece with impedance of 32 ohms. The earpiece must be low impedance one since the sound pressure is to be generated using current and not voltage as the supply voltage is restricted to 2.7V. The earpiece is driven directly by the UEM and the earpiece driver in UEM is a bridge amplifier. In NPM-6/6X 8mm PICO type earpiece is used.

Figure 11: Internal speaker



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Memory Block

For the MCU the UPP includes 2 kbytes ROM, that is used mainly for boot code of MCU. To speed up the MCU operation small 64 byte cache is also integrated as a part of the MCU memory interface. For program memory 8Mbit (512 x 16bit) PDRAM is integrated. RAM is mainly for MCU purposes but also DSP has also access to it if needed.

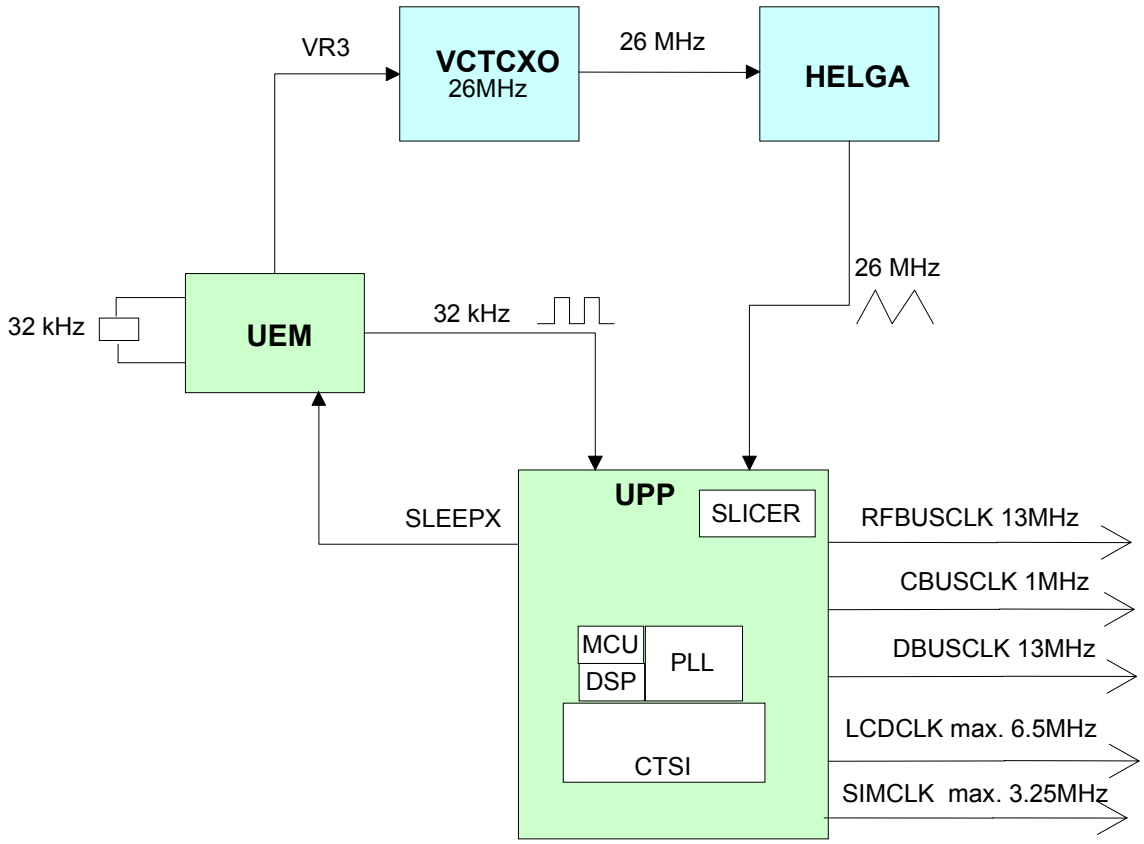
MCU code is stored into external flash memory. Size of the flash is 64Mbit (4096 x 16bit).

Security

The phone flash program and IMEI codes are software protected using an external security device that is connected between the phone and a PC.

Clock distribution

Figure 12: Clock Distribution Diagram



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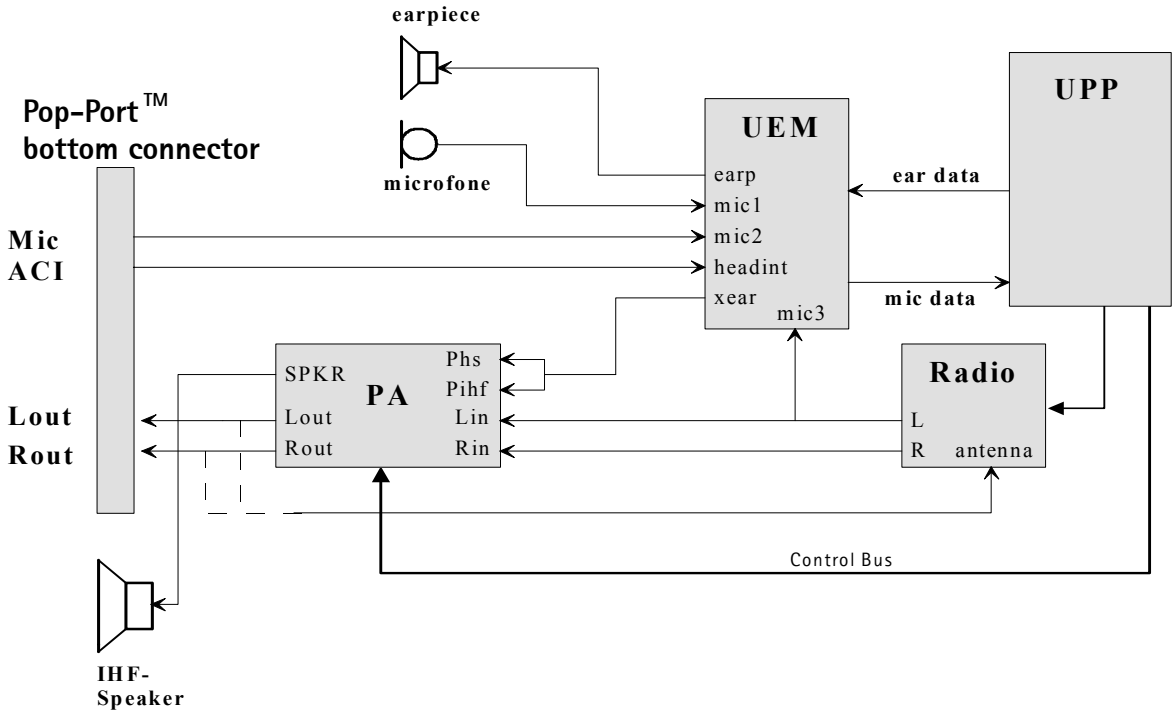
Audio Control

Figure 13: Audio block diagram NPM-6/6X



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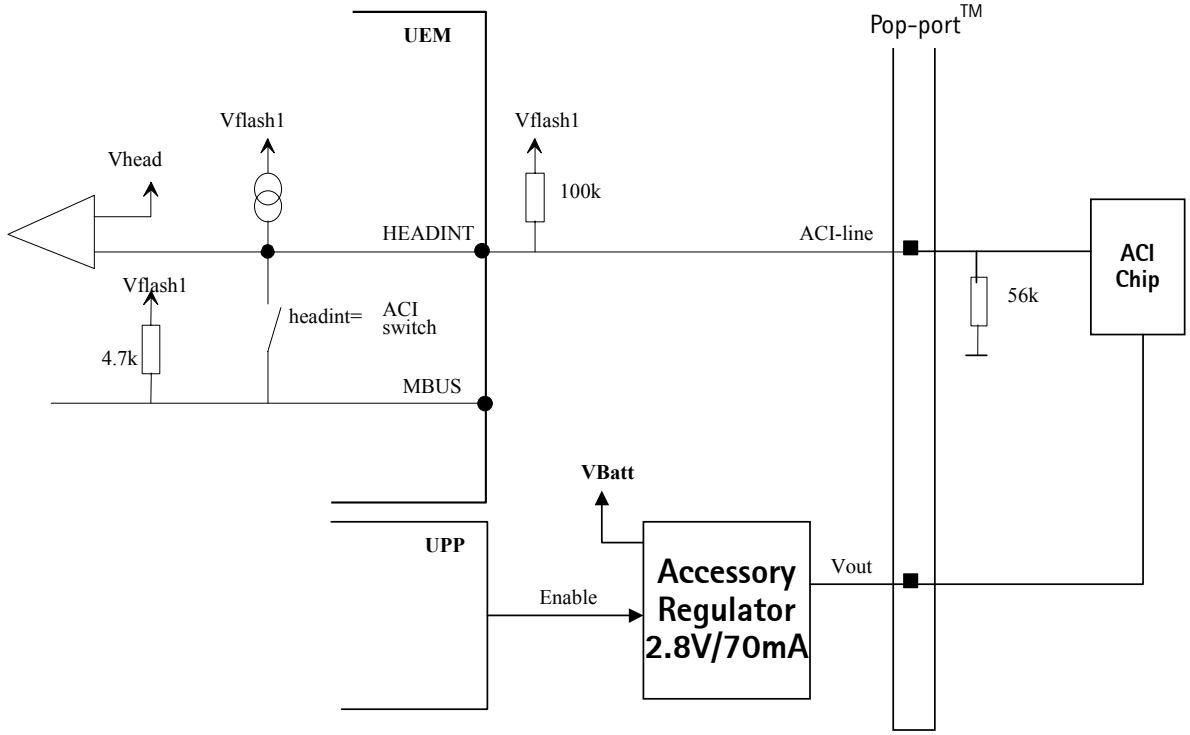
Accessory identification and Power Supply

Figure 14: Accessory identification and Power supply



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RF Module

The RF module comprises all RF functions of the NPM-6/6X engine. it is a triple band EGSM900 / GSM1800 / GSM1900 transceiver

It is supporting GGSM1800PRS, EGPRS and HSCSD protocols and multislot classes 1 to 6.

Transmitter and receiver have been implemented by using direct conversion architecture which means that the modulator and demodulator operate at the channel frequency.

The core of the RF is the Helga RF ASIC. Other main components include

- the power amplifier module which includes two amplifier chains, one for EGSM900 and the other for GSM1800/GSM1900.

- 26 MHz VCTCXO for frequency reference,

- 3420-3980 MHz SHF VCO (super high frequency voltage controlled oscillator),

- front end module with a RX/TX switch and

two RF bandpass SAW filters inside, and three additional SAW filters. EGSM900 and GSM1800 LNA's (low noise amplifier) for the receiver front-end are integrated in the Helga while GSM1900 LNA is external.

The RF module includes metal shields for PA, the Helga and FM Radio.

Internal antenna is based on the PIFA concept (planar inverted F-antenna).

The RF is controlled by the baseband section of the engine through a serial bus, referred later on as RFBus. This serial bus is used to pass the information about the frequency band, mode of operation, and synthesizer channel for the RF. In addition, exact timing information and receiver gain settings are transferred through the RFBus.

Physically, the bus is located between the baseband ASIC called UPP and the Helga. Using the information obtained from UPP the Helga controls itself to the required mode of operation and further sends control signals to the front end and power amplifier modules. In addition to the RFBus there are other interface signals for the power control loop and VCTCXO control and for the modulated waveforms.

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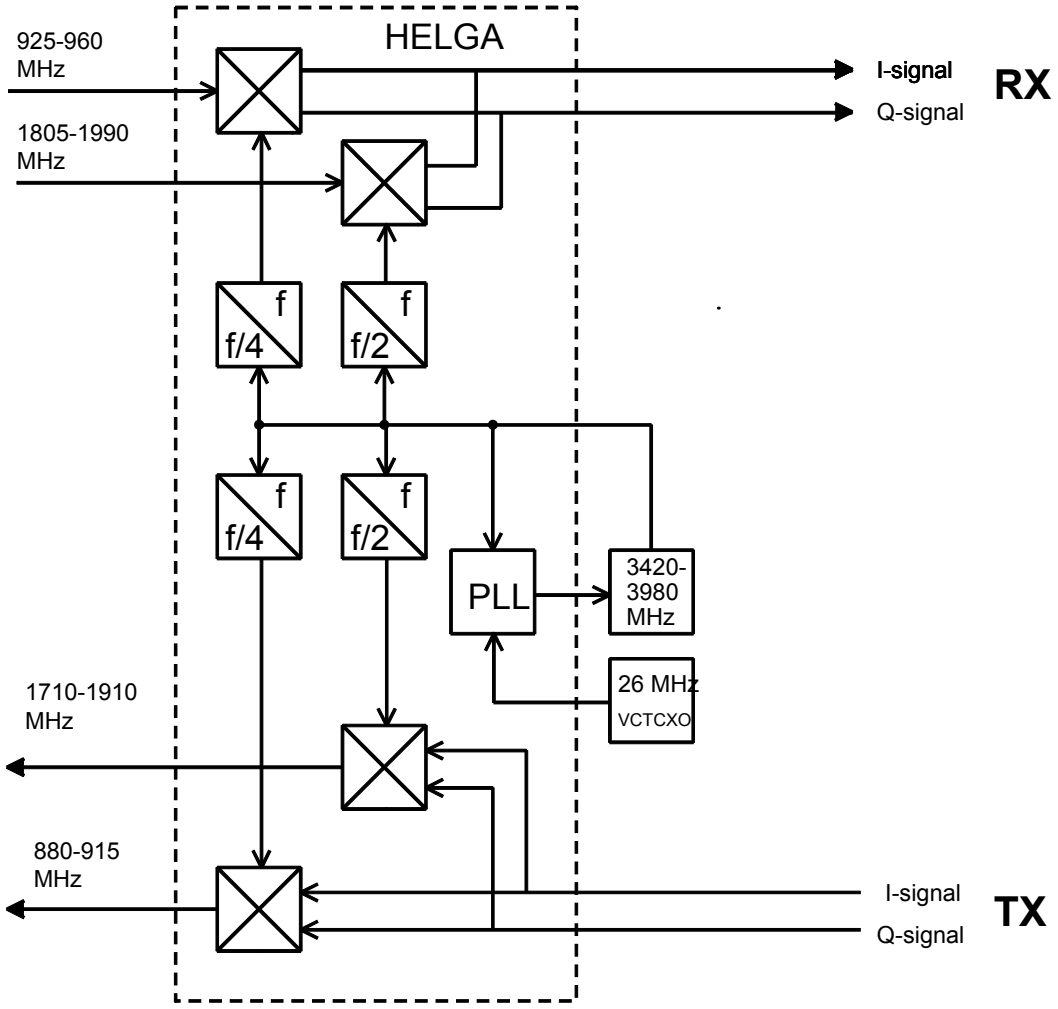
RF Frequency Plan

Figure 15: RF Frequency plan



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DC characteristics

Regulators

The transceiver baseband section has a multi function analog ASIC, UEM, which contains among other functions six pieces of 2.78 V linear regulators and a 4.8 V switching regulator. All the regulators can be controlled individually by the 2.78 V logic directly or through a control register. Normally, direct control is needed because of switching speed requirement: the regulators are used to enable the RF-functions which means that the controls must be fast enough.

The seven regulators are named VR1 to VR7. VrefRF01 is used as the reference voltages for the Helga, VrefRF01 (1.35V) for the bias reference and for the RX ADC (analog-to-digital converter) reference.

The regulators (except for VR7) are connected to the Helga. Different modes of operation can be selected inside the Helga according to the control information coming through the RFBus.

List of the needed supply voltages

Volt. source	Load
VR1	PLL charge pump (4.8 V)
VR2	TX modulators, ALCs, driver
VR3	VCTCXO, synthesizer digital parts
VR4	Helga pre-amps, mixers, DtoS
VR5	dividers, LO-buffers, prescaler
VR6	LNAs, Helga baseband (Vdd_bb)
VR7	VCO
VrefRF01	ref. voltage for Helga
Vbatt	PA

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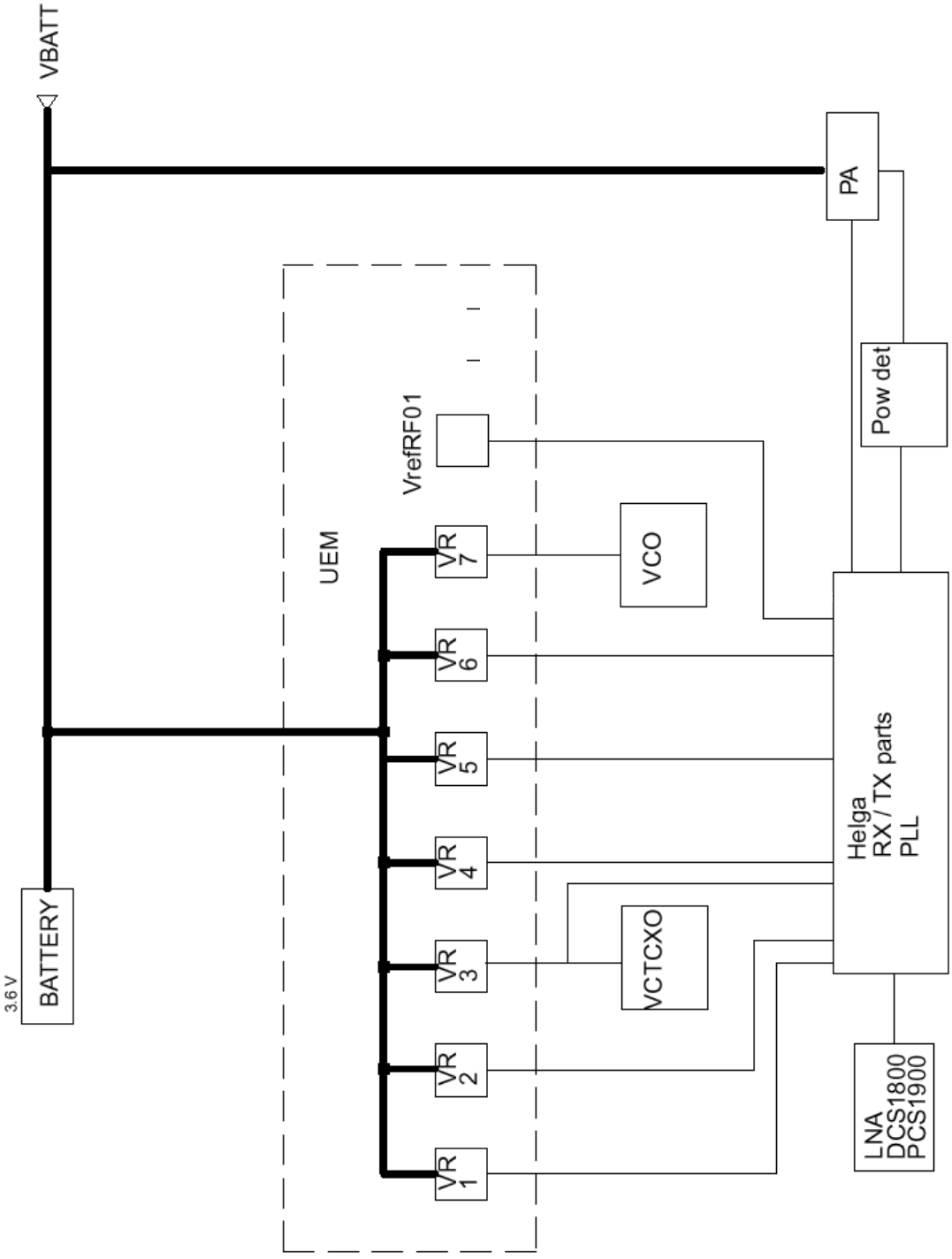
Power Distribution

Figure 16: Power distribution diagram



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RF characteristics

Parameter	Unit and value
Cellular System	EGSM900, GSM1800 and GSM1900
RX Frequency Band	EGSM900: 925 - 960 MHz GSM1800: 1805 - 1880 MHz GSM1900: 1930 - 1990 MHz
TX Frequency Band	EGSM900: 880 - 915 MHz GSM1800: 1710 - 1785 MHz GSM1900: 1850 - 1910 MHz
Output Power	EGSM900: +5...+33 dBm / 3.2 mW... 2 W GSM1800: +0...+30 dBm / 1.0 mW... 1 W GSM1900: +0...+30 dBm / 1.0 mW... 1 W
Number of RF Channels	EGSM900: 174 GSM1800: 374 GSM1900: 300
Channel Spacing	200 kHz
Number of TX Power Levels	EGSM900 : 15 GSM1800: 16 GSM1900: 16

Transmitter characteristics

Item	Values EGSM900/GSM1800/GSM1900
Type	Direct conversion, nonlinear, FDMA/TDMA
LO frequency range	3520...3660 MHz / 3420...3570 MHz/ 3700...3820 MHz
Output power	2 W / 1 W/1W peak
Gain control range	min. 30 dB
Maximum phase error (RMS/peak)	max 5 deg./20 deg.

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Receiver characteristics

Item	Values EGSM900/GSM1800/GSM1900
Type	Direct conversion, Linear, FDMA/TDMA
LO frequencies	3700...3840 MHz / 3610...3760 MHz/3860...3980 MHz
Typical 3 dB bandwidth	+/- 91 kHz
Sensitivity	min. - 102 dBm (GSM1800/GSM1900 norm.cond. only)
Total typical receiver voltage gain (from antenna to RX ADC)	86 dB
Receiver output level (RF level -95 dBm)	230 mVpp, single-ended I/Q signals to RX ADCs
Typical AGC dynamic range	83 dB
Accurate AGC control range	60 dB
Typical AGC step in LNA	30 dB GSM1800/GSM1900, 25 dB EGSM900
Usable input dynamic range	-102... -10 dBm
RSSI dynamic range	-110... -48 dBm
Compensated gain variation in receiving band	+/- 1.0 dB

RF Block Diagram

The block diagram of the RF module can be seen in Chapter on “RF Block Diagram”. The detailed functional description is given in the following sections

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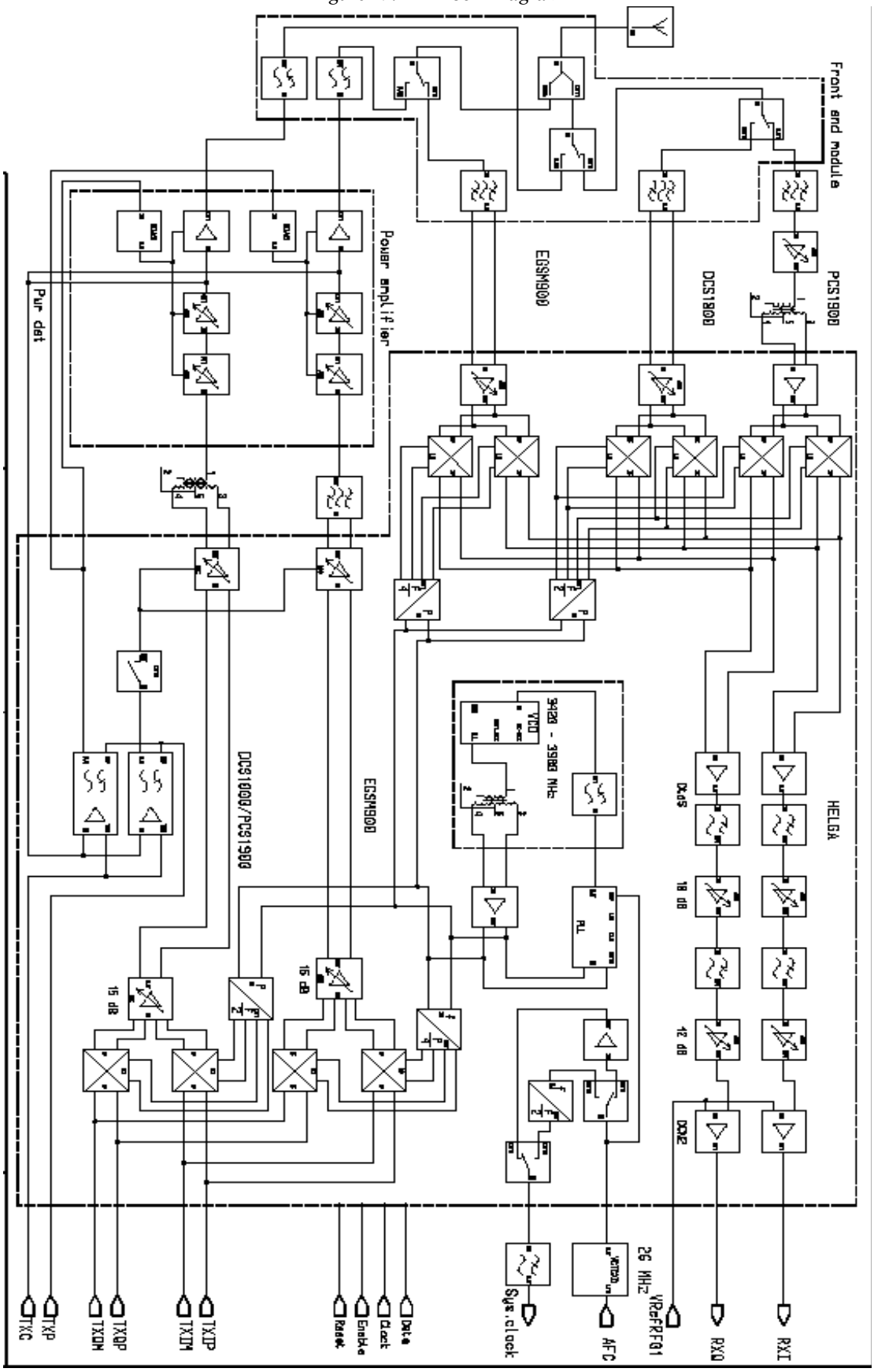
RF Block Diagram NPM-6/6X

Figure 17: RF Block Diagram



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Frequency synthesizers

The VCO frequency is locked by a phase locked loop (PLL) and VCTCXO which is running at 26 MHz.

The frequency of the VCTCXO is in turn locked into the frequency of the base station with the help of an AFC voltage which is generated in UEM by an 11 bit D/A (digital-to-analog) converter.

The PLL is located in the Helga and is controlled through the RFBus.

Loop filter filters out the comparison pulses of the phase detector and generates a DC control voltage to the VCO.

The dividers are controlled via the RFBus. RFBusData is for the data, RFBusClk is a serial clock for the bus and RFBusEna1X is a latch enable, which stores the new data into the dividers.

Receiver

Each receiver path is a direct conversion linear receiver.

From the antenna the received RF-signal is fed to the front end module where a diplexer first divides the signal to two separate paths according to the band of operation: either lower, EGSM900 or upper, GSM1800/GSM1900 path.

At each of the paths a pin-diode switch is used to select either receive or transmit mode. At the upper band in receive mode either GSM1800 or GSM1900 path is further selected by another pin-diode switch.

The selections are controlled by the Helga which obtains the mode/band and timing information through the RFBus. After the switches there is a bandpass filter at each of the receiver paths. These filters are included in the front end module, except for GSM1900 where it is external.

Then the signal is fed to the LNAs which are integrated in the Helga in EGSM900 and GSM1800 while in GSM1900 the LNA is external.

In GSM1900 the amplified signal is fed to a balun and thereafter to a pregain stage of the mixer while in EGSM900 and GSM1800 the LNA's are directly connected to the pregain stages without having SAW filters in between. The pregain stages as well as all the following receiver blocks are integrated in the Helga. The LNAs have three gain levels. The first one is the maximum gain, the second one is about 30 dB below the maximum, and the last one is the off state.

After the pregain stages there are demodulator mixers at each signal path to convert the RF signal directly down to baseband I and Q signals. Local oscillator signals for the mixers are generated by an external VCO the frequency of which is divided by two in GSM1800 and GSM1900 and by four in EGSM900. Those frequency dividers are integrated in the Helga and in addition to the division they also provide accurate phase

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shifting by 90 degrees which is needed for the demodulator mixers.

The demodulator output signals are all differential. After the demodulators the amplifiers convert the differential signals to single ended. Before that, they combine the signals from the three demodulators to a single path which means that from the output of the demodulators to the baseband interface there are just two signal paths (I and Q) which are common to all the frequency bands of operation.

In addition, the amplifiers perform the first part of the channel filtering and AGC: they have two gain stages, the first one with a constant gain of 12 dB and 85 kHz -3 dB bandwidth and the second one with a switchable gain of 6 dB and -4 dB. The filters in the amplifier blocks are active RC filters. The rest of the analog channel filtering is provided by blocks called BIQUAD.

After the amplifier and BIQUAD blocks there is another AGC-amplifier which provides a gain control range of 42 dB in 6 dB steps.

In addition to the AGC steps, the last AGC stage also performs the real time DC offset compensation which is needed in a direct conversion receiver.

DC offset compensation is performed during the operations called DCN1 and DCN2. DCN1 is carried out by charging off-chip capacitors in the last AGC stages to a voltage which causes a zero DC offset. DCN2 is used to set the signal offset to a constant value, VrefRF_02 which is 1.35 V. That voltage level is then used as a zero level for RX ADCs which are located in UEM.

After the last AGC and DC offset compensation stages the single ended and filtered I- and Q-signals are finally fed to the RX ADCs. The maximum peak-to-peak voltage swing for the ADCs is 1.45 V.

In the Helga there is a port called RF-temp which can be used for compensation of RX SAW filters thermal behavior. The temperature information to the Helga comes from a voltage over two diodes when the diodes are fed with temperature independent, constant current.

Transmitter

The transmitter consists of two final frequency IQ-modulators and power amplifiers, for the lower and upper bands separately, and a power control loop. The IQ-modulators are integrated in the Helga, as well as the operational amplifiers of the power control loop. The two power amplifiers are located in a single module which also includes the power detector and the directional coupler. Loop filter parts of the power control loop are implemented as discrete components on the PWB. In the GMSK mode the power is controlled by adjusting the DC bias levels of the power amplifiers.

The modulated waveforms, i.e. the I- and Q-signals, are generated by the baseband part of the engine module. After post filtering, implemented as RC-networks, they go into the IQ-modulator. Local oscillator signals for the modulator mixers are generated by an external VCO the frequency of which is divided by two in GSM1800 and in GSM1900 and

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by four in EGSM900. Those frequency dividers are integrated in the Helga and in addition to the division they also provide accurate phase shifting by 90 degrees which is needed for the modulator mixers.

At the upper band there is a dual mode buffer amplifier at the output of the IQ-modulator. The final amplification is realized by a three stage power amplifier.

There are two different amplifier chains in a single amplifier module, one for EGSM900 and one for GSM1800/GSM1900. The lower band power amplifier is able to deliver over 2 W of RF power, while the capability of the upper band amplifier is over 1 W.

In the GMSK mode the gain control is implemented by adjusting the bias voltages of the first two transistor stages thereby reaching the dynamic range of over 70 dB.

After the power amplifier the signal goes through a low pass filter and a pin-diode switch which is used to select between the reception and transmission. Finally, the two signal paths, lower and upper band, are combined in a diplexer after which the signal is routed through the antenna.

Power control circuitry consists of a power amplifier and an error amplifier. The power amplifier produces a voltage level related to the value of the RF voltage. It is fed to the negative input of the error amplifier where it is compared to the level of the reference signal, TXC, obtained from UEM. Depending on the difference between the two signals the biases of the power amplifier stages are either increased or decreased to get the correct power level out of the power amplifier.

Front End

The front end module includes:

- Antenna 50 ohm input

- RX GSM1900 single output, RX EGSM900 and GSM1800 balanced output

- TXs EGSM900 and GSM1800/GSM1900 single 50 ohm input

-3 control lines from the Helga

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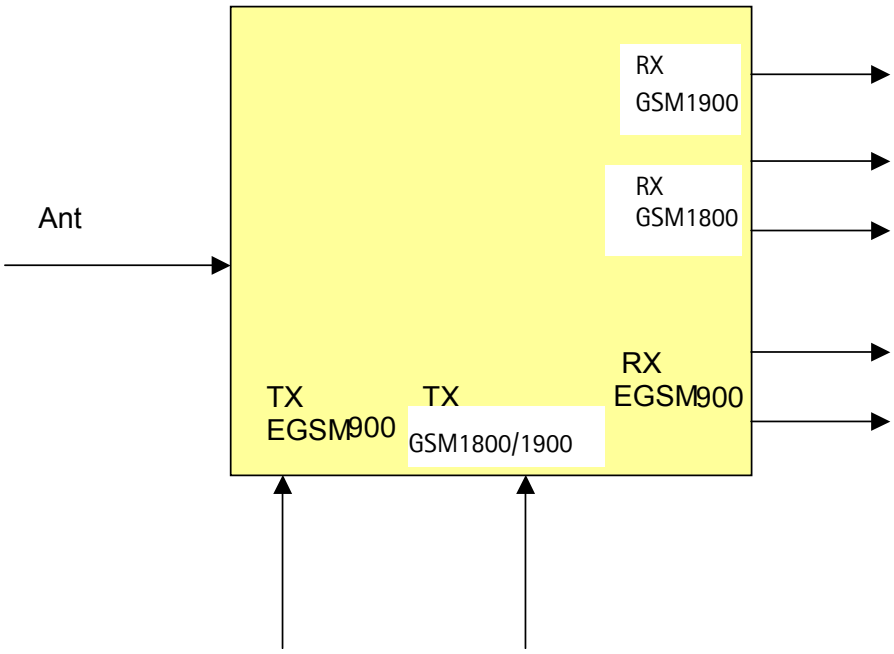
Figure 18: Front End



Power Amplifier

The power amplifier features include:

- 50 ohm input and output, EGSM900 and GSM1800/GSM1900

- internal power detector

- low and high power mode (EGSM900)

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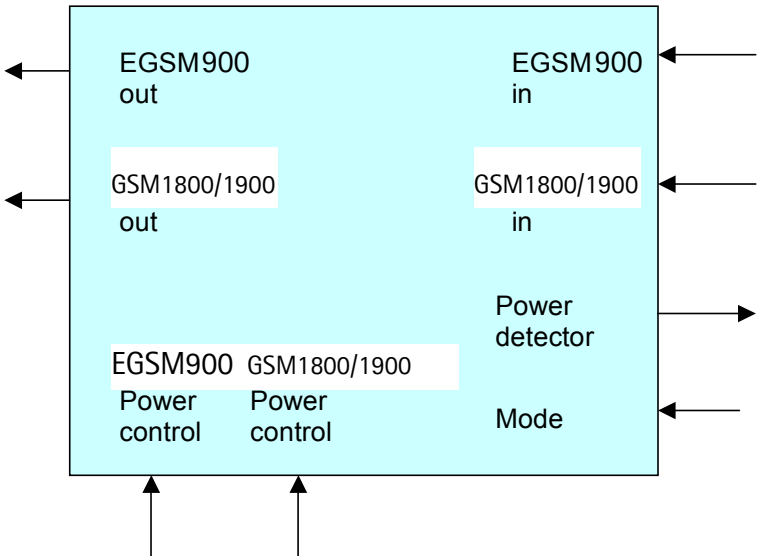
Figure 19: Power amplifier



RF ASIC Helga

The RF ASIC module includes:

- Package uBGA108

- Balanced I/Q demodulator and balanced I/Q modulator

- Power control operational amplifier, acts as an error amplifier

- The signal from VCO is balanced, frequencies 3420 to 3980 MHz

- EGSM900 and GSM1800 low noise amplifier (LNA) are integrated.

The Helga can be tested by test points only.

AFC function

AFC is used to lock the transceiver's clock to the frequency of the base station.

Antenna

The NPM-6/6X EGSM900/GSM1800/GSM1900 transceiver features an internal antenna.

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